Switch-Mode Power Rectifiers

MUR405, MUR410, MUR415, MUR420, MUR440, MUR460

These state-of-the-art devices are a series designed for use in switching power supplies, inverters and as free wheeling diodes.

Features

- Ultrafast 25 ns, 50 ns and 75 ns Recovery Times
- 175°C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- Reverse Voltage to 600 V
- Shipped in Plastic Bags, 500 per Bag
- Available in Tape and Reel, 1500 per Reel, by Adding a "RLG" Suffix to the Part Number
- MUR460 available in Fan Fold Ammo Pak, 1000 per Box, by adding a "FFG" suffix to the part number
- These are Pb–Free Packages*

Mechanical Characteristics:

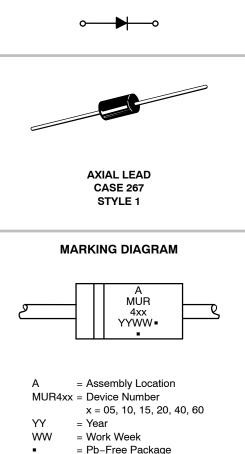
- Case: Epoxy, Molded
- Weight: 1.1 Gram (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Cathode indicated by Polarity Band



ON Semiconductor®

www.onsemi.com

ULTRAFAST RECTIFIERS 4.0 AMPERES, 50–600 VOLTS



(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MAXIMUM RATINGS

		MUR						
Rating	Symbol	405	410	415	420	440	460	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	50	100	150	200	400	600	V
Average Rectified Forward Current (Square Wave) (Mounting Method #3 Per Note 2)	I _{F(AV)}	4	.0 @ T	_A = 80°	C	4.0 T _A =	-	А
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, half wave, single phase, 60 Hz)	I _{FSM}		12	25		11	0	А
Operating Junction Temperature & Storage Temperature	T _J , T _{stg}			— 65 t	o +175	•		°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

		MUR						
Rating	Symbol	405	410	415	420	440	460	Unit
Maximum Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$			See N	lote 2			°C/W
Maximum Thermal Resistance, Junction-to-Case Body	$\Psi_{\theta JC}$			6	.6			°C/W

ELECTRICAL CHARACTERISTICS

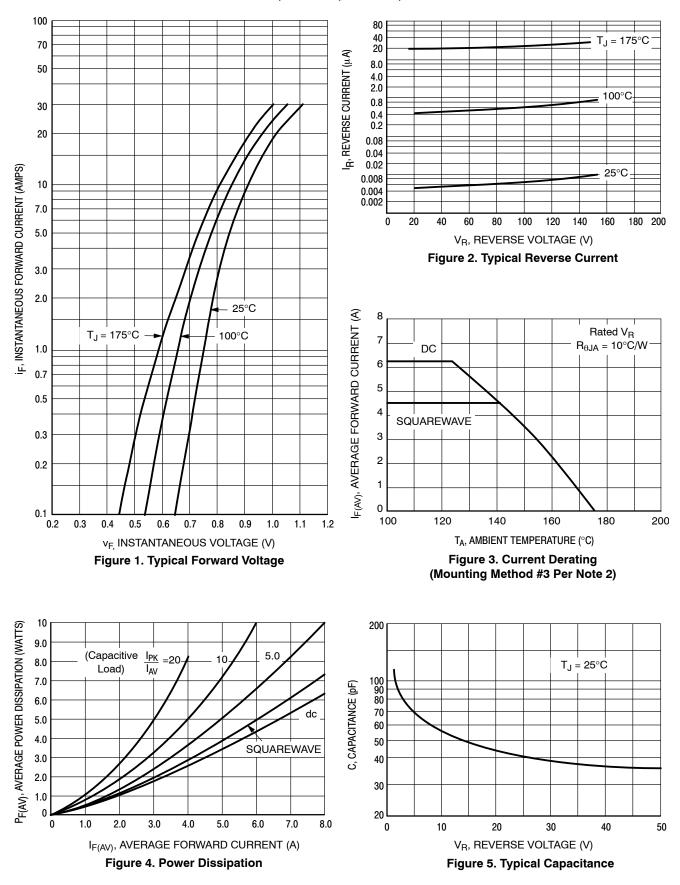
		MUR						
Rating	Symbol	405	410	415	420	440	460	Unit
	VF	0.71 1.05 0.88 1.25 0.89 1.28				25	V	
Maximum Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_J = 150^{\circ}C$) (Rated dc Voltage, $T_J = 25^{\circ}C$)	t (Note 1) i _R 150 250 5 10		μA					
Maximum Reverse Recovery Time ($I_F = 1.0 \text{ A}$, di/dt = 50 A/µs) ($I_F = 0.5 \text{ A}$, $i_R = 1.0 \text{ A}$, $I_{REC} = 0.25 \text{ A}$)	μs) 35 75		ns					
Maximum Forward Recovery Time (I _F = 1.0 A, di/dt = 100 A/ μ s, Recovery to 1.0 V)	t _{fr}		2	5		5	0	ns
Controlled Avalanche Energy (Maximum)	W _{aval}				5			mJ
Typical Peak Reverse Recovery Current $(I_F = 1.0 \text{ A}, \text{ di/dt} = 50 \text{ A}/\mu\text{s})$	I _{RM}		0	.8	•	1	.7	A

1. Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%.

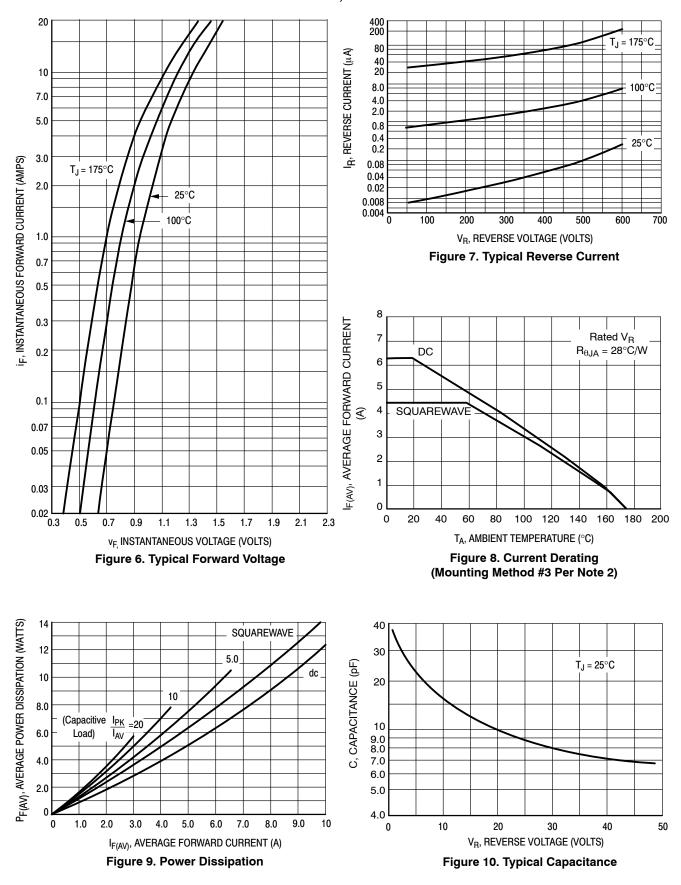
ORDERING INFORMATION

Device	Package	Shipping [†]
MUR405G	Axial Lead*	
MUR410G	Axial Lead*	500 Units / Bag
MUR410RLG	Axial Lead*	1500 / Tape & Reel
MUR415G	Axial Lead*	500 Units / Bag
MUR415RLG	Axial Lead*	1500 / Tape & Reel
MUR420G	Axial Lead*	500 Units / Bag
MUR420RLG	Axial Lead*	1500 / Tape & Reel
MUR440G	Axial Lead*	500 Units / Bag
MUR440RLG	Axial Lead*	1500 / Tape & Reel
MUR460G	Axial Lead*	500 Units / Bag
MUR460FFG	Axial Lead*	1000 Units / Box
MUR460RLG	Axial Lead*	1500 / Tape & Reel

†For information on tape and reel and ammo pak specifications, including part orientation, tape sizes and box dimensions, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
*These packages are inherently Pb-Free.

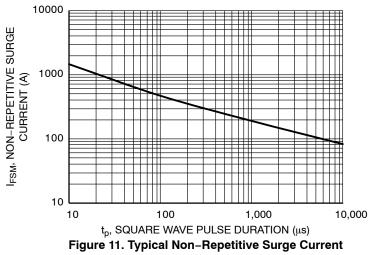


MUR405, MUR410, MUR415, MUR420



MUR440, MUR460

MUR440, MUR460



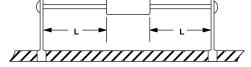
*Typical performance based on a limited sample size. ON Semiconductor does not guarantee ratings not listed in the Maximum Ratings table.

NOTE 2 — AMBIENT MOUNTING DATA

Data shown for thermal resistance junction-to-ambient $(R_{\theta JA})$ for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

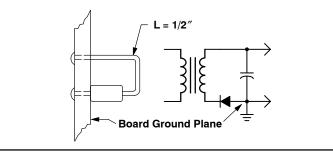
TYPICAL VALUES FOR $\textbf{R}_{\theta \textbf{JA}}$ IN STILL AIR

Mounti	ing	Lea				
Metho	bd	1/8	1/4	1/2	3/4	Units
1		50	51	53	55	°C/W
2	R _{0JA}	58	59	61	63	°C/W
3			2	28		°C/W



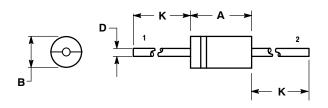
MOUNTING METHOD 3

P.C. Board with $1-1/2'' \times 1-1/2''$ Copper Surface



PACKAGE DIMENSIONS

AXIAL LEAD CASE 267-03 (DO-201AD) **ISSUE G**



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.287	0.374	7.30	9.50
В	0.189	0.209	4.80	5.30
D	0.047	0.051	1.20	1.30
Κ	1.000		25.40	

STYLE 1: PIN 1. CATHODE (POLARITY BAND) 2. ANODE

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PUBLICATION ORDERING INFORMATION

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